

WSJM65R360 Super-Junction Power MOSFET

Rev.01 - 22 January 2024

Product data sheet

1. General description

WSJM65R360 is a high voltage N-channel MOSFET in TO220 package, which utilizes the advanced super-junction technology to provide superior FOM $R_{DS(on)} * Q_g$ among silicon based MOSFETs. It is particularly suitable for applications require extreme high efficiency and power density.



2. Features and benefits

- Superior FOM $R_{DS(on)} * Q_g$
- Extremely low switching loss
- 100% avalanche tested

3. Applications

- PFC stage and/or DC/DC converters in various high efficiency power suppliers, e.g. TV/sever/telecom/lighting power suppliers
- Inverters and motor drives

4. Quick reference data

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| Table 1. Qu | lick reference data | | | | | | | |
|---------------------|-------------------------------------|--|-------|------------|-----|------|------|--|
| Symbol | Parameter | Conditions | Notes | Values | | Unit | | |
| Absolute | maximum rating | | | | | | | |
| V _{DS} | drain-source voltage | | | | 650 | | V | |
| V_{GS} | gate-source voltage | | | | ±30 | | V | |
| I _D | continuous drain current | T _{mb} = 25 °C | | | 12 | | А | |
| P _{tot} | power dissipation | T _{mb} = 25 °C | | 139 | | W | | |
| Tj | junction temperature | | | -55 to 150 | | °C | | |
| Symbol | Parameter | Conditions | Notes | Min | Тур | Max | Unit | |
| Static cha | aracteristics | | | | Ì | Ì | Ì | |
| $R_{\text{DS(on)}}$ | drain-source on-state resistance | V _{GS} = 10 V, I _D = 5.5 A | | - | 335 | 360 | mΩ | |
| Dynamic | Dynamic characteristics | | | | | | | |
| Q _{G(tot)} | total gate charge | $I_{\rm D}$ = 5.5 A; $V_{\rm DS}$ = 400 V; $V_{\rm GS}$ = 10 V | | - | 18 | - | nC | |
| E _{oss} | coss stored erergy | V_{GS} = 0 V; V_{DS} = 0 to 400 V | | - | 2.6 | - | μJ | |

5. Pinning information

| Pin | Symbol | Description | Simplified outline | Graphic symbol |
|-----|--------|-----------------------------------|--------------------|----------------|
| 1 | G | gate | mb | D |
| 2 | D | drain | | \rightarrow |
| 3 | S | source | | |
| mb | D | mounting base; connected to drain | | svm300 S |

6. Ordering information

| Table 3. Ordering information | | | | | | | | |
|-------------------------------|-----------------|-----------------------|----------------|---------------------------|-----------------|-----------------------|--|--|
| Type number | Package name | Orderable part number | Packing method | Small packing quantity | Package version | Package issue date | | |
| WSJM65R360 | TO220 | WSJM65R360Q | Tube | 50 | SOT78 | 13-Jun-2008 | | |

7. Marking

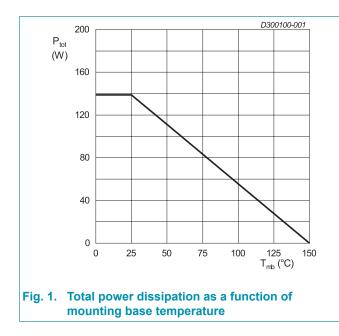
| Table 4. Marking codes | |
|------------------------|----------------|
| Type number | Marking codes |
| WSJM65R360 | WSJM 65R360 |

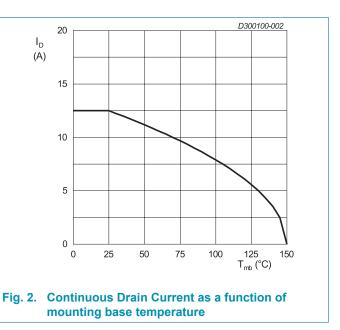
8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

| Symbol | Parameter | Conditions | Notes | Values | Unit |
|---------------------|--|---|-------|------------|------|
| V _{DS} | drain-source voltage | | | 650 | V |
| V _{GS} | gate-source voltage | | | ±30 | V |
| I _D | continuous drain current | T _{mb} = 25 °C | | 12 | А |
| | | T _{mb} = 100 °C | | 7.9 | А |
| I _{DM} | pulsed drain current | T _{mb} = 25 °C | | 48 | А |
| P _{tot} | power dissipation | T _{mb} = 25 °C | | 139 | W |
| E _{AS} | single pulse drain-to- source avalanche | I_{AS} = 3.3 A; R _{GS} = 25 Ω; V _{DD} = 50 V; T _j = 25 °C | | 54 | mJ |
| E _{AR} | repetitive avalanche energy | I_{AS} = 3.3 A; R _{GS} = 25 Ω; V _{DD} = 50 V; T _j = 25 °C | | 0.6 | mJ |
| I _{AS} | avalanche current, single pulse | | | 3.3 | A |
| dv/dt | MOSFET dv/dt ruggedness | | | 50 | V/ns |
| dv/dt | reverse diode dv/dt | | | 15 | V/ns |
| dl _F /dt | maximum diode commutation speed | | | 500 | A/µs |
| T _{stg} | storage temperature | | | -55 to 150 | °C |
| Tj | junction temperature | | | -55 to 150 | °C |

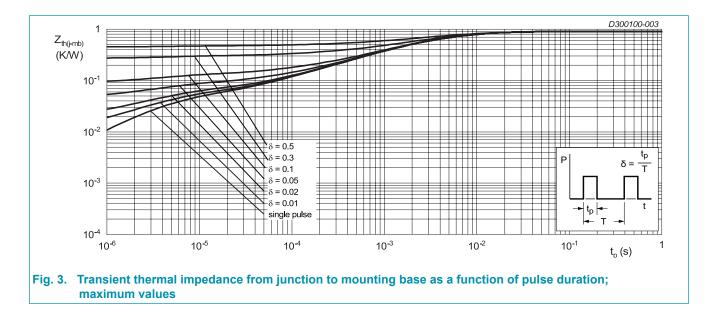




9. Thermal & Mechanical characteristics

Table 6. Thermal & Mechanical characteristics

| Symbol | Parameter | Conditions | Notes | Min | Тур | Max | Unit |
|----------------|---|-------------|-------|-----|------|------|------|
| $R_{th(j-mb)}$ | thermal resistance from junction to mounting base | | | - | 0.66 | 0.90 | K/W |
| $R_{th(j-a)}$ | thermal resistance from junction to ambient | in free air | | - | 60 | - | K/W |



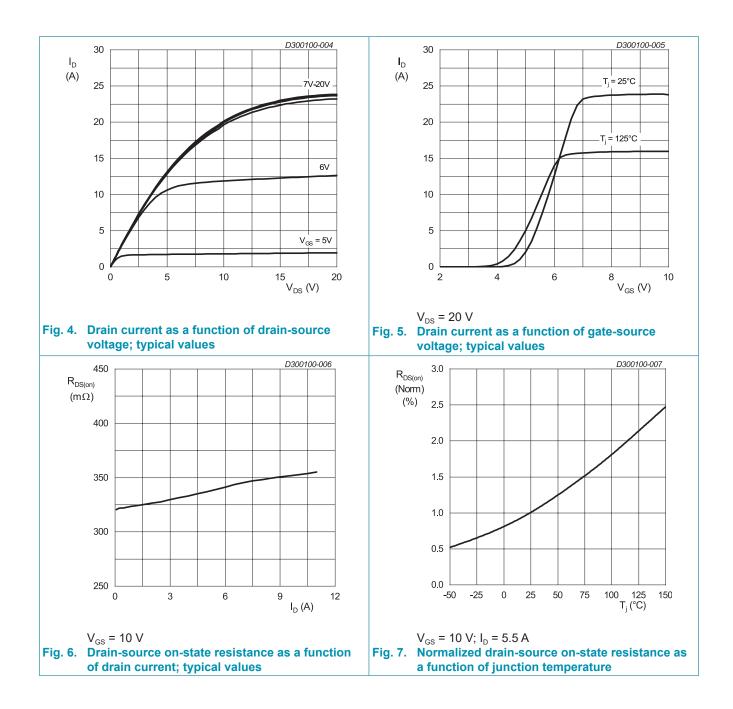
10. Characteristics

Table 7. Characteristics

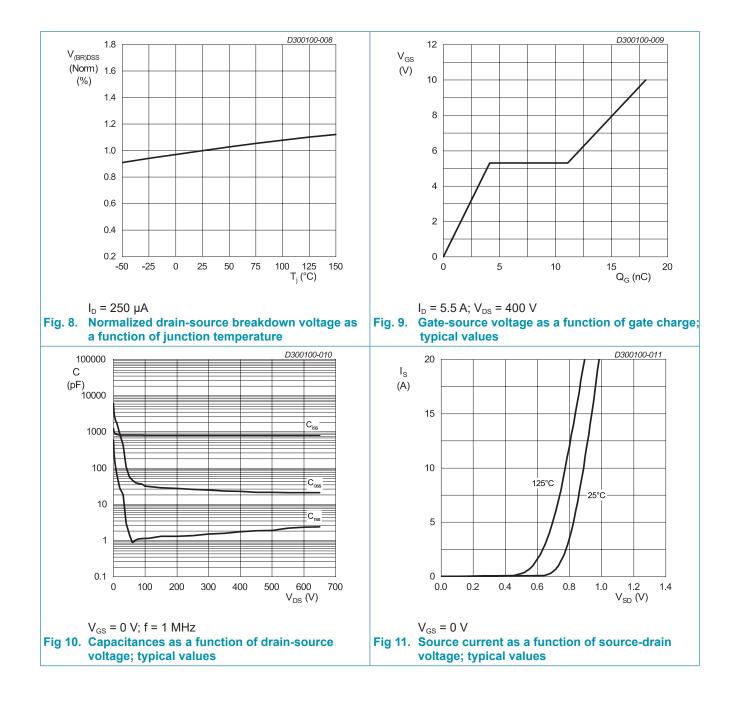
T_j = 25 °C unless otherwise noted

| Symbol | Parameter | Conditions | Notes | Min | Тур | Max | Unit |
|---------------------|--|--|-------|-----|-----|------|------|
| Static cha | aracteristics | | | | | | |
| $V_{(BR)DSS}$ | drain-source breakdown voltage | $I_{\rm D}$ = 250 µA; $V_{\rm GS}$ = 0 V | | 650 | - | - | V |
| $V_{\text{GS(th)}}$ | gate-source threshold voltage | I_D = 250 µA; V_{DS} = V_{GS} | | 2.5 | - | 4.5 | V |
| I _{DSS} | drain leakage current | $V_{\rm DS}$ = 650 V; $V_{\rm GS}$ = 0 V | | - | - | 1 | μA |
| | | V_{DS} = 650 V; V_{GS} = 0 V; T_j = 125 °C | | - | - | 10 | μA |
| I _{GSS} | gate leakage current | $V_{GS} = \pm 30 \text{ V}; V_{DS} = 0 \text{ V}$ | | - | - | ±100 | nA |
| $R_{\text{DS(on)}}$ | drain-source on-state resistance | V_{GS} = 10 V; I _D = 5.5 A | | - | 335 | 360 | mΩ |
| R _G | gate resistance | f = 1 MHz | | - | 18 | - | Ω |
| Dynamic | characteristics | | | | | | |
| Q _{G(tot)} | total gate charge | I _D = 5.5 A; V _{DS} = 400 V; V _{GS} = 10 V | | - | 18 | - | nC |
| Q _{GS} | gate-source charge | | | - | 4.1 | - | nC |
| Q _{GD} | gate-drain charge | | | - | 7.0 | - | nC |
| C _{iss} | input capacitance | V _{DS} = 400 V; V _{GS} = 0 V; f = 1 MHz | | - | 808 | - | pF |
| C _{oss} | output capacitance | | | - | 23 | - | pF |
| $C_{\rm rss}$ | reverse transfer capacitance | | | - | 1.8 | - | pF |
| $C_{o(er)}$ | effective output capacitance, energy related | V_{GS} = 0 V; V_{DS} = 0 to 400 V | | - | 33 | - | pF |
| C _{o(tr)} | effective output capacitance, time related | | | - | 148 | - | pF |
| t _{d(on)} | turn-on delay time | $V_{DS} = 400 \text{ V}; V_{GS} = 10 \text{ V}; \text{ R}_{G} = 2 \Omega;$ | | - | 30 | - | ns |
| t _r | rise time | $I_{D} = 5.5 A$ | | - | 9.6 | - | ns |
| t _{d(off)} | turn-off delay time | | | - | 52 | - | ns |
| t _f | fall time | | | - | 14 | - | ns |
| Source-d | rain diode | | | | | | |
| V _{SD} | source-drain voltage | V _{GS} = 0 V; I _S = 5.5 A | | - | 0.8 | 1.1 | V |
| ls | body-diode continuous current | T _{mb} = 25 °C | | - | - | 12 | A |
| t _{rr} | reverse recovery time | $V_{\textrm{R}}$ = 400 V; $\textrm{I}_{\textrm{F}}$ = 5.5 A; dI_{\textrm{F}}/dt = 100 A/µs | | - | 229 | - | ns |
| Q _{rr} | reverse recovered charge | | | - | 2.3 | - | μC |
| I _{rrm} | reverse recovery current | | | - | 20 | - | Α |

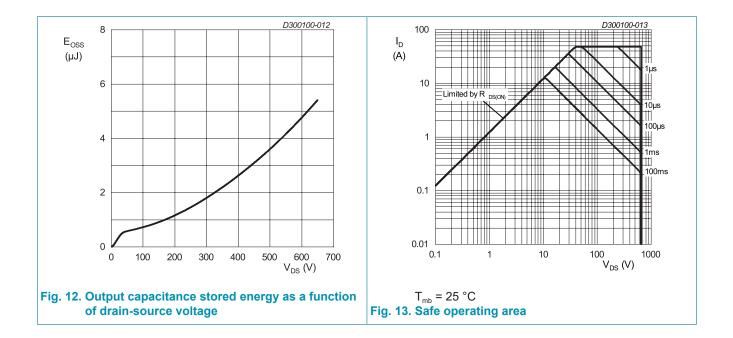
Super-Junction Power MOSFET



Super-Junction Power MOSFET

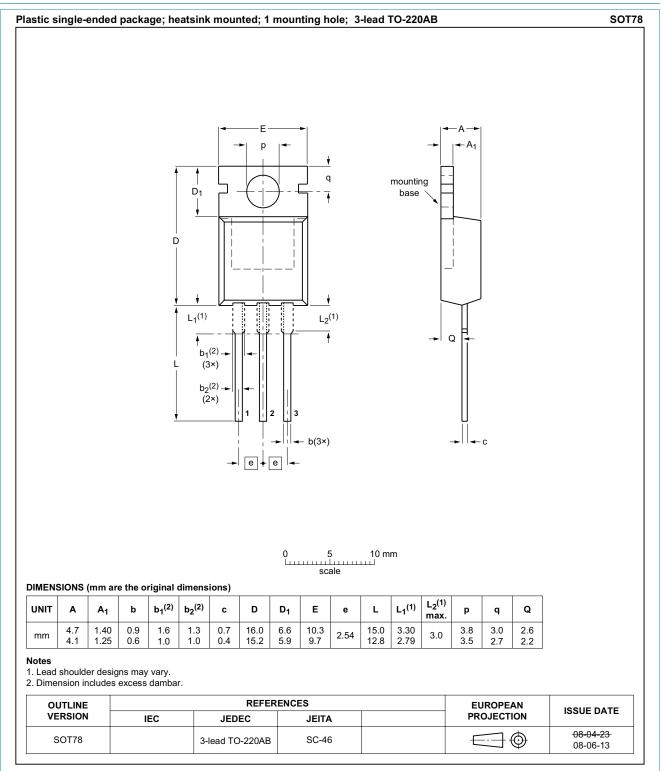


WSJM65R360 Super-Junction Power MOSFET



Super-Junction Power MOSFET

11. Package outline



WSJM65R360 Product data sheet

Super-Junction Power MOSFET

12. Legal information

Data sheet status

| Document status [1][2] | Product status [3] | Definition |
|--------------------------------------|-----------------------|---|
| Objective [short] data sheet | Development | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet | Qualification | This document contains data from the preliminary specification. |
| Product [short] data sheet | Production | This document contains the product specification. |

[1] Please consult the most recently issued document before initiating or completing a design.

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